



LMN400B01

400mA LOAD SWITCH FEATURING PNP TRANSISTOR AND N-MOSFET WITH GATE PULL-DOWN RESISTOR

Product Summary

Reference	Device Type	R1 (NOM)	R2 (NOM)	R3 (NOM)	Figure
Q1	PNP Transistor	10K	220	_	2
Q2	N-MOSFET			37K	2

Features

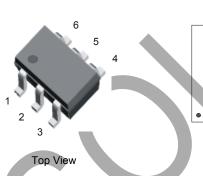
- Voltage Controlled Small Signal Switch
- N-MOSFET with Gate Pull-Down Resistor
- Ideally Suited for Automated Assembly Processes
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

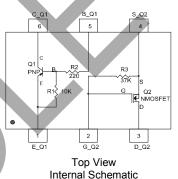
Description

LMN400B01 is best suited for applications where the load needs to be turned on and off using control circuits like micro-controllers, comparators etc. particularly at a point of load. It features a discrete pass transistor with stable $V_{\text{CE}(\text{SAT})}$ which does not depend on input voltage and can support continuous maximum current of 400 mA . It also contains a discrete N-MOSFET with gate pull-down resistor that can be used as control. The component devices can be used as a part of a circuit or as a stand alone discrete device.

Mechanical Data

- Case: SOT26
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture sensitivity: Level 1 per J-STD-020C
- Terminal Connections: See Diagram
- Terminals; Finish Matte Tin annealed over Copper leadframe.
 Solderable per MIL-STD-202, Method 208 3
- Weight: 0.016 grams (approximate)





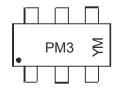
Ordering Information (Note 4)

Part Number	Case	Packaging
LMN400B01-7	SOT26	3000/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

- 2. See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com.

Marking Information



PM3 = Product Type Marking Code, YM = Date Code Marking Y = Year, e.g., Z = 2012 M = Month, e.g., 9 = September

Date Code Key

Year	2006	20	007		2012	2	013	2014	2015	20	16	2017
Code	T		U		Z		Α	В	С		1	Е
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P_{D}	300	mW
Power Derating Factor above +100°C	P _{DER}	2.4	mW/°C
Output Current	I _{OUT}	400	mA

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C
Thermal Resistance, Junction to Ambient Air (Note 5)	$R_{ heta JA}$	417	°C/W

Maximum Ratings:

Pre-Biased PNP Transistor (Q1) (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V_{CBO}	-50	V
Collector-Emitter Voltage	V_{CEO}	-50	V
Supply Voltage	Vcc	-50	V
Input Voltage	V _{IN}	-6 to +5	V
Output Current	Ic	-400	mA

Maximum Ratings:

ESD Protected N-Channel MOSFET (Q2) (@TA = +25°C, unless otherwise specified.)

Ch	aracteristic	Symbol	Value	Unit
Drain-Source Voltage		V_{DSS}	60	V
Drain Gate Voltage (R _{GS} ≤1MΩ)		V_{DGR}	60	V
Gate-Source Voltage	Continuous	M	+/-20	V
	Pulsed (tp < 50µS)	V_{GSS}	+/-40	V
Drain Current (Note 5)	Continuous (V _{GS} = 10V)	1	115	mA
	Pulsed (tp <10µS, Duty Cycle <1%)	ID	800	IIIA
Continuous Source Current		Is	115	mA

Note: 5. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.



Electrical Characteristics: Pre-Biased PNP Transistor (Q1) (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 6)							
Collector-Base Cut Off Current	I _{CBO}		_	-500	nA	$V_{CB} = -50V, I_{E} = 0$	
Collector-Emitter Cut Off Current	I _{CEO}		_	-1	μΑ	V _{CE} = -50V, I _B = 0	
Collector-Base Breakdown Voltage	V _{(BR)CBO}	-50		_	V	$I_C = -10\mu A, I_E = 0$	
Collector-Emitter Breakdown Voltage	V _{(BR)CEO}	-50		_	V	$I_{C} = -2mA, I_{B} = 0$	
Input Off Voltage	V _{I(OFF)}	-0.3		_	V	$V_{CE} = -5V$, $I_C = -100\mu A$	
Ouput Current	I _{O(OFF)}			-1	μΑ	$V_{CC} = -50V, V_{I} = 0V$	
ON CHARACTERISTICS (Note 6)	ON CHARACTERISTICS (Note 6)						
		_	-0.06	-0.15	V	$I_C = -10mA$, $I_B = -0.3mA$	
Collector-Emitter Saturation Voltage	V _{CE(SAT)}		-0.18	-0.30	V	$I_C = -300$ mA, $I_B = -30$ mA	
			-0.28	-0.60	>	$I_C = -500 \text{mA}, I_B = -50 \text{mA}$	
		55	220		d	$V_{CE} = -5V, I_{C} = -50mA$	
DC Current Gain	h	55	260			$V_{CE} = -5V, I_{C} = -100mA$	
DC Current Gain	h _{FE}	55	265			V_{CE} = -5V, I_{C} = -200 mA	
		55	225			$V_{CE} = -5V, I_{C} = -400mA$	
Input On Voltage	$V_{I(ON)}$	-3.0	-1.5		V_{DC}	$V_{O} = -0.3V$, $II_{C} = -2mA$	
Input Current	l _i		-18	-45	mA	V _I = -5V	
Base-Emitter Turn-on Voltage	V _{BE(ON)}		-1.2	-1.6	V	V _{CE} = -5V, I _C = -400mA	
Base-Emitter Saturation Voltage		_	-1.9	-2.5	V	$I_C = -50 \text{mA}, I_B = -5 \text{mA}$	
base-Emiller Saturation voltage	$V_{BE(SAT)}$	_	-5.25	-6.00	V	I _C = -400mA, I _B = -20mA	
Input Resistor (Base), +/- 30%	R2	0.154	0.220	0.286	ΚΩ	_	
Pull-up Resistor (Base to V _{CC} supply), +/- 30%	R1	7	10	13	ΚΩ	_	
Resistor Ratio (Input Resistor/Pullup resistor)	R1/R2	36	45	55		_	
SMALL SIGNAL CHARACTERISTICS							
Gain Bandwidth Product	f⊤		200		MHz	$V_{CE} = -10V, I_{E} = -5mA,$ f = 100MHz	

* Pulse Test: Pulse width, tp <300 μ s, Duty Cycle, d \leq 0.02 Note: 6. Short duration pulse test used to minimize self-heating effect.





Electrical Characteristics: ESD Protected N-Channel MOSFET (Q2) (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS (Note 6)			•					
Drain-Source Breakdown Voltage	V _{(BR)DSS}	60	_	_	V	$V_{GS} = 0V, I_D = 10\mu A$		
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μΑ	V _{GS} =0V, V _{DS} = 60V		
Gate-Body Leakage Current, Forward	I _{GSSF}	_	_	0.95	mA	V _{GS} = 20V, V _{DS} = 0V		
Gate-Body Leakage Current, Reverse	I _{GSSR}	_	_	-0.95	mA	V _{GS} = -20V, V _{DS} = 0V		
ON CHARACTERISTICS (Note 6)	ON CHARACTERISTICS (Note 6)							
Gate Source Threshold Voltage	V _{GS(th)}	1	1.6	2.5	V	$V_{DS} = V_{GS}, I_{D} = 0.25 \text{mA}$		
Static Drain Source On State Voltage	V		0.09	1.5	V	V_{GS} = 5V, I_D = 50mA		
Static Drain-Source On-State Voltage	V _{DS(on)}	_	0.6	3.75	V	V _{GS} = 10V, I _D = 500mA		
On-State Drain Current	I _{D(on)}	500	_		mA	$V_{GS} = 10V$, $V_{DS} \ge 2*V_{DS(ON)}$		
Static Drain-Source On Resistance	R _{DS(on)}	_	1.6	3	Ω	V _{GS} = 5V, I _D = 50mA		
Static Drain-Source Off Resistance		_	1.2	2	17	V _{GS} = 10V, I _D = 500mA		
Forward Transconductance	9 FS	80	260	_	mS	$V_{DS} \ge 2*V_{DS(ON)}$, $I_D = 200 \text{ mA}$		
Gate Pull-Down Resistor, +/- 35%	R3	_	37		kΩ	_		
DYNAMIC CHARACTERISTICS						· ·		
Input Capacitance	Ciss	_		50	pF			
Output Capacitance	Coss	_		25	pF	$V_{DS} = -25V$, $V_{GS} = 0V$, $f = 1MHz$		
Reverse Transfer Capacitance	Crss	_	_	5	pF			
SWITCHING CHARACTERISTICS*								
Turn-On Delay Time	td _(on)	+		20	ns	$V_{DD} = 30V, V_{GS} = 10V,$		
Turn-Off Delay Time	td _(off)	1	7	40	ns	$I_D = 200 \text{mA},$ $R_G = 25\Omega, R_L = 150\Omega$		
SOURCE-DRAIN (BODY) DIODE CHARACTERISTICS AND MAXIMUM RATINGS								
Drain-Source Diode Forward On-Voltage	V_{SD}	4	0.88	1.5	V	$V_{GS} = 0V$, $I_S = 300 \text{ mA*}$		
Maximum Continuous Drain-Source Diode Forward Current (Reverse Drain Current)	Is		_	300	mA	_		
aximum Pulsed Drain-Source Diode Forward Current	Ism		_	800	mA	_		

^{*} Pulse Test: Pulse width, tp <300µs, Duty Cycle, d ≤0.02

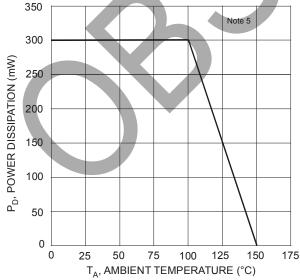
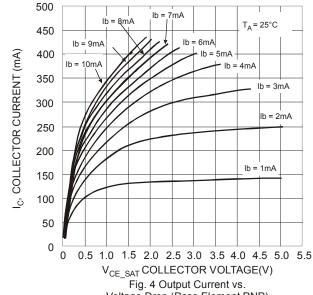


Fig. 3 Max Power Dissipation vs. Ambient Temperature



T_A = 25°C

_A= 85°C



Pre-Biased PNP Transistor Characteristics

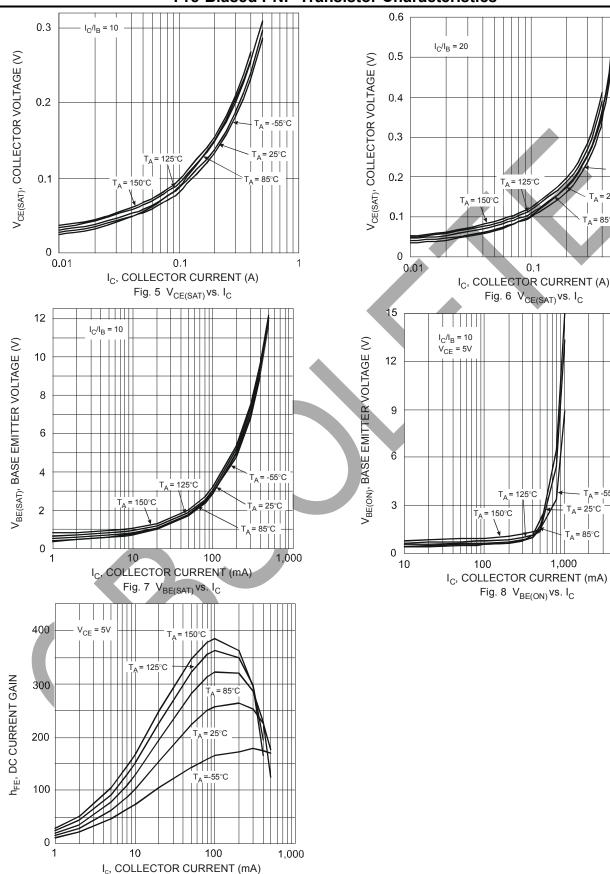
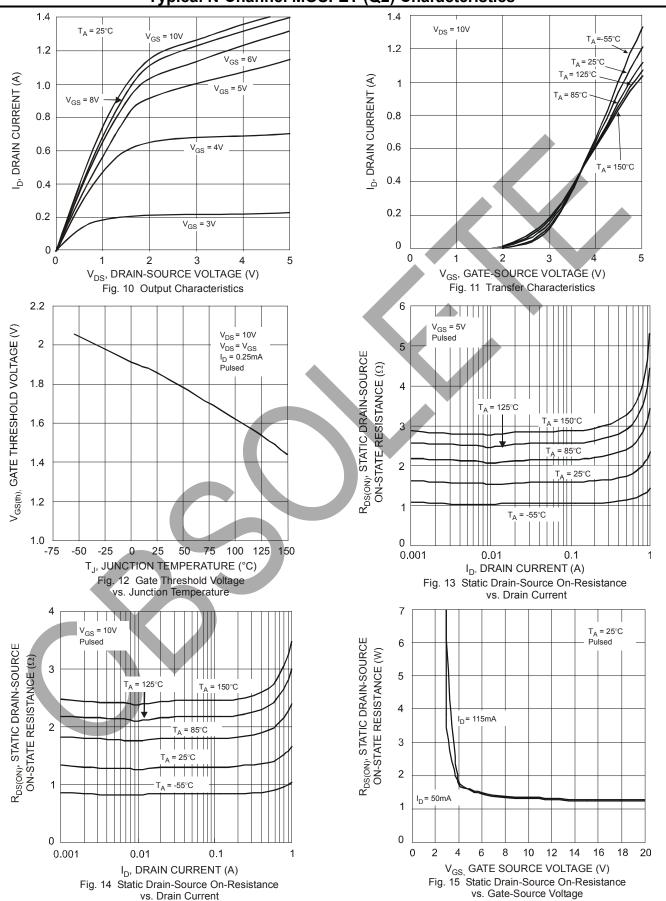


Fig. 9 h_{FE} vs. I_C

10,000

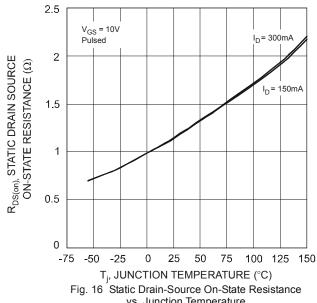


Typical N-Channel MOSFET (Q2) Characteristics

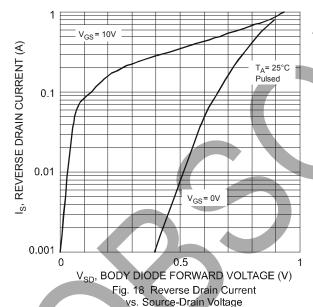


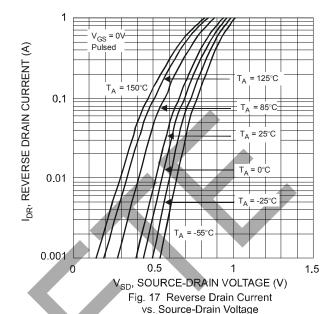


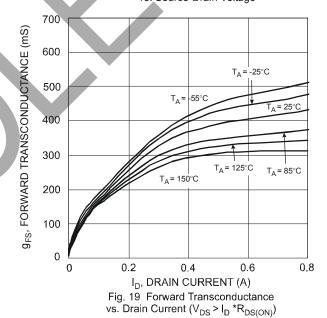
Typical N-Channel MOSFET (Q2) Characteristics (cont.)



vs. Junction Temperature









Application Details

PNP Transistor and ESD Protected N-MOSFET integrated as one in LMN400E01 can be used as a discrete entity for general applications or as an integrated circuit to function as a Load Switch. When it is used as the latter as shown in Figure 20, various input voltage sources can be used as long as it does not exceed the maximum ratings of the device. These devices are designed to deliver continuous output load current up to a maximum of 400mA. The MOSFET Switch draws no current, hence the loading of the control circuitry is prevented. Care must be taken for higher levels of dissipation while designing for higher load conditions. These devices provide high power and also consume less space. The product mainly helps in optimizing power usage, thereby conserving battery life in a controlled load system like portable battery powered applications. (Please see Figure 21 for one example of a typical application circuit used in conjunction with a voltage regulator as a part of power management system).

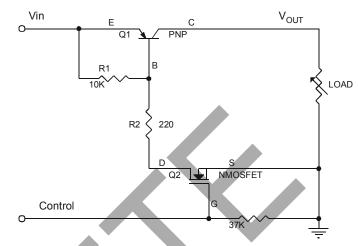


Figure 20 Circuit Diagram

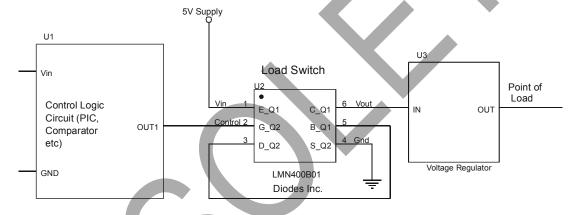
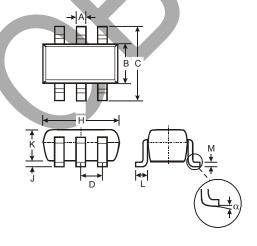


Figure 21 Typical Application Circuirt

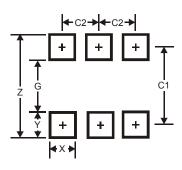
Package Outline Dimensions



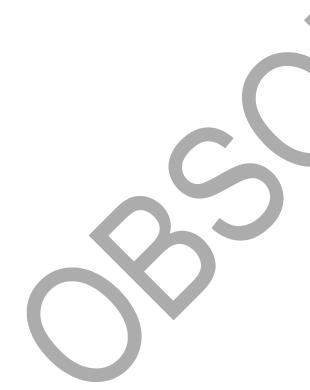
	SOT26						
Dim	Min	Max	Тур				
Α	0.35	0.50	0.38				
В	1.50	1.70	1.60				
С	2.70	3.00	2.80				
D	_	_	0.95				
Н	2.90	3.10	3.00				
J	0.013	0.10	0.05				
K	1.00	1.30	1.10				
L	0.35	0.55	0.40				
М	0.10	0.20	0.15				
α	0°	8°	_				
All D	imensi	ons in	mm				



Suggested Pad Layout



Dimensions	Value (in mm)
Z	3.20
G	1.60
Х	0.55
Y	0.80
C1	2.40
C2	0.95





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